APPLICABLE STANDARD

VOLTAGE			150V AC		CUF	CURRENT		1A			
RATING	OPERATING TEMPERATURE RANGE		-35°C TO + 85°C(N	IOTE 1)	ТЕМ	STORAGE TEMPERATURE RANGE		-10°C	-10°C TO + 60°C (NOTE 3)		
RATING	OPERATING HUMIDITY RANGE		20% TO 80% (NOT	E 2)	1	STORAGE HUMIDITY RANGE		20%	20% TO 70% (NOTE 3)		
	APPLICABLE CONNECTOR		L DE10 C 1 050 L		PLAICABLE IMP CONTACT		DF13-2	DF13-2630SCF, DF13-3032SCF			
	•		SPEC	IFIC/	ATIO	NS		•			
I	ГЕМ	TEST METHOD				REQUIREMENTS				QT	АТ
CONSTR	RUCTION										
GENERAL EXAMINATION							ACCORDING TO DRAWING.				
MARKING		CONFIRMED VISUALLY.									X
ELECTR	IC CHARA										
CONTACT RESISTANCE		100m A (DC OR 1000 Hz).					30mΩ MAX.				_
INSULATION RESISTANCE		100V DC.				500MΩ MIN.				Х	_
VOLTAGE PROOF		500V AC FOR 1 min.				NO FLASHOVER OR BREAKDOWN.				Х	_
MECHAN	VICAL CHA	RACT	FRISTICS								
MECHANIC.			ES INSERTIONS AND EXTR	RACTIO	NS.	① COI	NTACT RF	SISTANCF.	30mΩ MAX.		
OPERATION						2 NO	NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				_
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.				2 NO	ELECTRICAL DISCONTINUITY OF 1µs. DAMAGE, CRACK OR LOOSENESS PARTS.				-
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.				① NO ② NO	ELECTRICAL DISCONTINUITY OF 1µs. DAMAGE, CRACK OR LOOSENESS PARTS.				_
ENVIRO	NMENTAL	CHAR	ACTERISTICS				174(10.			<u> </u>	I
RAPID CHA			RATURE -55→ 5 TO 35→+8	5→ 5 T	O 35 °C	① CO1	NTACT RES	SISTANCE:	30mΩ MAX.		
TEMPERATURE		TIME $30 \rightarrow 5$ TO 15 $\rightarrow 30 \rightarrow 5$ TO 15 min UNDER 5 CYCLES.				② INSULATION RESISTANCE: 500MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				X	_
DAMP HEAT (STEADY STATE)		, , , , , , , , , , , , , , , , , , ,				 CONTACT RESISTANCE: 30mΩ MAX. INSULATION RESISTANCE: 500MΩ MIN. NO DAMAGE, CRACK OR LOOSENESS OF PARTS. 				X	_
RESISTANCE TO SOLDERING HEAT		1 ′				NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINALS.				Х	_
SOLDERABILITY		SOLDERED AT SOLDER TEMPERATURE, 215±5°C FOR INSERTION DURATION, 3 SECONDS.				SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.				Х	_
NOTE 2: NO NOTE 3:APP BEF	CONDENSING. PLY TO THE CO FORE PCB ON I	NDITION C BOARD AF IS APPLIE	URE RISE BY CURRENT. DE LONG TERM STORAGE FOR TER PCBBOARD, OPERATING TORAGE DE CONTRE DE CONTR	NG TEMI	PERATUF FRANSPO	RE AND ORTATIO		CHE	CKED	DA	TE
M		DESCRIPTION OF REVISIONS			DESIGNED			CHECKED			
Unless otherwise specifid , refer to JIS C 5402.							APPROVE	ΞD	TY.OMA	06.0	9.25
		,					CHECKE		(.UMEHARA	06.0	
							DESIGNE		.KUMAZAWA	06.0	
							DRAWN		AK.MIURA	06.0	
Note QT:Qualification Test AT:Assurance Test X:Applicable Test DI					RAWIN	IG NO.	El	LC4-162420			

PART NO.

CODE NO

DF13-*P-1. 25DS (20)

CL536

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SPECIFICATION SHEET

HIROSE ELECTRIC CO., LTD.